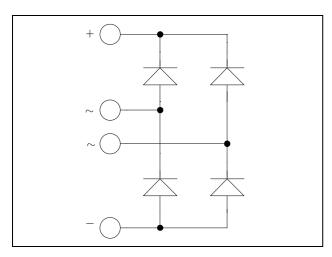


ISOTOP® Rectifier diode full bridge Power Module

$$V_{RRM} = 1600V$$

 $I_F = 90A @ Tc = 80°C$



Application

• Input mains rectifier

Features

- Planar double passivated chips
- High blocking voltage
- High current
- Low leakage current
- Very low stray inductance
- High level of integration
- ISOTOP® Package (SOT-227)



Benefits

- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit		
V_R	Maximum DC reverse Voltage			1600	V
V_{RRM}	Maximum Peak Repetitive Reverse Voltage	1000	V		
I_{F}	DC Forward Current		$T_C = 90^{\circ}C$	80	٨
I_{FSM}	Non-Repetitive Forward Surge Current	t=10ms	$T_J = 45^{\circ}C$	850	А

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



All ratings @ $T_i = 25^{\circ}C$ unless otherwise specified

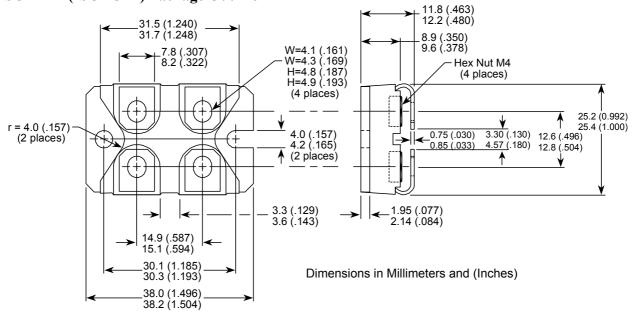
Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit	
I_R	Reverse Current	$V_R = 1600V$	$T_j = 25^{\circ}C$		50		μΑ
			$T_j = 125$ °C		4		mA
V_{F}	Forward Voltage	$I_F = 90A$	$T_j = 25$ °C		1.3		V
			$T_j = 125$ °C		1.1		·
V_{T}	On – state Voltage				0.8		V
r_{T}	On – state Slope resistance				4.8		mΩ

Thermal and package characteristics

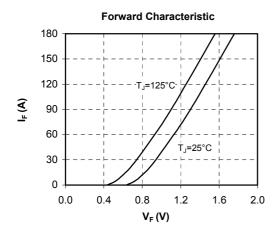
Symbol	Characteristic	Min	Тур	Max	Unit
R_{thJC}	Junction to Case Thermal resistance			0.85	°C/W
R_{thJA}	Junction to Ambient			20	C/ W
V_{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz	2500			V
T_{J}, T_{STG}	Storage Temperature Range	-55		150	°C
$T_{ m L}$	Max Lead Temp for Soldering:0.063" from case for 10 sec			300	
Torque	Mounting torque (Mounting = 8-32 or 4mm Machine and terminals = 4mm Machine)			1.5	N.m
Wt	Package Weight		29.2		g

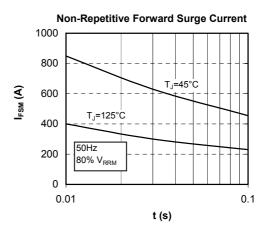
SOT-227 (ISOTOP®) Package Outline



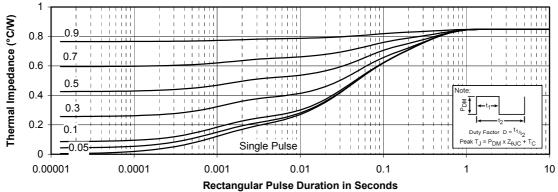


Typical Performance Curve









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